

Chipsmall Limited consists of a professional team with an average of over 10 year of expertise in the distribution of electronic components. Based in Hongkong, we have already established firm and mutual-benefit business relationships with customers from, Europe, America and south Asia, supplying obsolete and hard-to-find components to meet their specific needs.

With the principle of "Quality Parts, Customers Priority, Honest Operation, and Considerate Service", our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip, ALPS, ROHM, Xilinx, Pulse, ON, Everlight and Freescale. Main products comprise IC, Modules, Potentiometer, IC Socket, Relay, Connector. Our parts cover such applications as commercial, industrial, and automotives areas.

We are looking forward to setting up business relationship with you and hope to provide you with the best service and solution. Let us make a better world for our industry!



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CMPD1001 CMPD1001A CMPD1001S

SURFACE MOUNT HIGH CURRENT SILICON SWITCHING DIODE



www.centralsemi.com

DESCRIPTION:

The CENTRAL SEMICONDUCTOR CMPD1001 series types are silicon switching diodes manufactured by the epitaxial planar process, designed for applications requiring high current capability.



The following configurations are available:

CMPD1001	SINGLE	MARKING CODE: L20
CMPD1001A	DUAL, COMMON ANODE	MARKING CODE: L22
CMPD1001S	DUAL, IN SERIES	MARKING CODE: L21

MAXIMUM RATINGS: (T _A =25°C)	SYMBOL		UNITS
Continuous Reverse Voltage	V_{R}	90	V
Continuous Forward Current	l _F	250	mA
Peak Repetitive Forward Current	I _{FRM}	600	mA
Peak Repetitive Reverse Current	IRRM	600	mA
Peak Forward Surge Current, tp=1.0µs	I _{FSM}	6.0	Α
Peak Forward Surge Current, tp=1.0s	I _{FSM}	1.0	Α
Power Dissipation	P_{D}	350	mW
Operating and Storage Junction Temperature	T _J , T _{stg}	-65 to +150	°C
Thermal Resistance	Θ_{JA}	357	°C/W

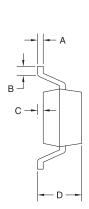
ELECTRICA	AL CHARACTERISTICS PER DIODE: (T _A =25°	C unless otherwise noted)	
SYMBOL	TEST CONDITIONS	MIN	MAX	UNITS
I_{R}	V _R =90V		100	nA
I_{R}	V _R =90V, T _A =150°C		100	μΑ
BV_R	I _R =100μA	90		V
V_{F}	I _F =10mA		0.75	V
V_{F}	I _F =50mA		0.84	V
٧ _F	I _F =100mA		0.90	V
V_{F}	I _F =200mA		1.00	V
V_{F}	I _F =400mA		1.25	V
C_T	V _R =0, f=1.0MHz		35	pF
t _{rr}	$I_R=I_F=30$ mA, Rec. to 3.0mA, $R_L=100\Omega$		50	ns

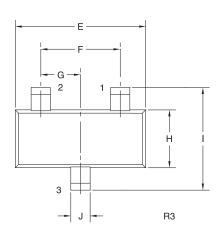
CMPD1001 CMPD1001A CMPD1001S

SURFACE MOUNT HIGH CURRENT SILICON SWITCHING DIODE



SOT-23 CASE - MECHANICAL OUTLINE

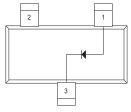




DIMENSIONS					
	INCHES		MILLIMETERS		
SYMBOL	MIN	MAX	MIN	MAX	
Α	0.003	0.007	0.08	0.18	
В	0.006	-	0.15	-	
С	-	0.005	-	0.13	
D	0.035	0.043	0.89	1.09	
E	0.110	0.120	2.80	3.05	
F	0.075		1.90		
G	0.037		0.95		
Н	0.047	0.055	1.19	1.40	
	0.083	0.098	2.10	2.49	
J	0.014	0.020	0.35	0.50	

SOT-23 (REV: R3)

PIN CONFIGURATIONS

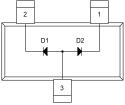


CMPD1001

LEAD CODE:

- 1) Anode
- 2) No Connection
- 3) Cathode

MARKING CODE: L20

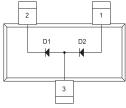


CMPD1001A

LEAD CODE:

- 1) Cathode D2
- 2) Cathode D1
- 3) Anode D1, Anode D2

MARKING CODE: L22



CMPD1001S

LEAD CODE:

- 1) Anode D2
- 2) Cathode D1
- 3) Anode D1, Cathode D2

MARKING CODE: L21

R6 (25-January 2010)

OUTSTANDING SUPPORT AND SUPERIOR SERVICES



PRODUCT SUPPORT

Central's operations team provides the highest level of support to insure product is delivered on-time.

- Supply management (Customer portals)
- · Inventory bonding
- · Consolidated shipping options

- · Custom bar coding for shipments
- · Custom product packing

DESIGNER SUPPORT/SERVICES

Central's applications engineering team is ready to discuss your design challenges. Just ask.

- Free guick ship samples (2nd day air)
- Online technical data and parametric search
- SPICE models
- · Custom electrical curves
- · Environmental regulation compliance
- · Customer specific screening
- · Up-screening capabilities

- · Special wafer diffusions
- PbSn plating options
- · Package details
- Application notes
- · Application and design sample kits
- Custom product and package development

REQUESTING PRODUCT PLATING

- 1. If requesting Tin/Lead plated devices, add the suffix "TIN/LEAD" to the part number when ordering (example: 2N2222A TIN/LEAD).
- If requesting Lead (Pb) Free plated devices, add the suffix "PBFREE" to the part number when ordering (example: 2N2222A PBFREE).

CONTACT US

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